



[click here](#)

SEARCH

[Articles](#)

[Buyers Guide](#)

[Advanced](#) | [Help](#)



[SAVE THIS](#)
[EMAIL THIS](#)
[PRINT THIS](#)

*****TODAY'S NEW PRODUCTS ONLINE*****

September 22, 2003 — Featuring **Materials**

Label Materials

XF-581, XF-582, XF-583 and XF-584 ultra-high-temperature labels under the Polyimide family of label materials are targeted for use in lead-free electronics applications, and all are available in colored versions. Additionally, the family of Polyimide label material is designed for barcode or alphanumeric identification of PCBs or related electronic components. The label is suitable for withstanding mixed circuit board processes, on either the top or bottom side of the board. The family is said to feature resistance to harsh fluxes, cleaners, saponifiers and wavesolder environments, and resists all commonly used methods of cleaning. Polyonics Inc., Westmoreland, N.H. <http://www.polyonics.com/>.

Solvents

The TravelSAFE packaging capability for solvents involves a special, non-flammable solvent, and a packaging system acceptable to the airline and shipping industries. Four non-flammable, non-hazardous cleaners have been selected for deployment in the TravelSAFE package. Each is based on a proprietary azeotrope of DuPont Vertrel specialty solvents. The solvents are Heavy Duty Degreaser C, Flux Remover C, Contact Cleaner C and Fiber Optic Connector Cleaner. Each formulation is said to be optimized for the contamination expected at the job site. Micro Care, New Britain, Conn.

Interested in a subscription to Surface Mount Technology Magazine?

[Click here](#) to subscribe!



QUICK VOTE

Sponsored by:



What did you think of SMTA International/Assembly Technology Expo?

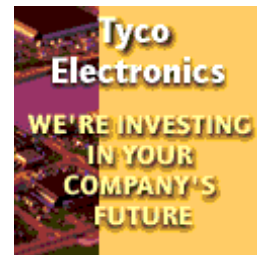
It was better than I expected

It was about what I expected

It was worse than I expected

I didn't go to SMTA International/Assembly Technology Expo

[View Results Only](#)



CURRENT ISSUE

September 2003



BUYERS GUIDE





[Click here to see the benefits](#)

NEW FROM SURFACE MOUNT TECHNOLOGY

[Webcast Archive:](#)
Doug Johnson from SiemensDEMATIC presents [Manufacturing Efficiency](#)
[Click here to view our Webcast Archives.](#)

PENNWELL CONNECTIONS

Advanced Packaging

[Global Solutions for Semiconductor Packaging](#)

CONNECTOR SPECIFIER

[Connection / Interconnection](#)
[Products * Technology](#)
[Updates * Industry News](#)

PORTABLE DESIGN

[The authority for mobile technologies and products](#)

LaserFocusWorld

[The Magazine for the Photonics & Optoelectronics Industry](#)



[Search](#) | [Contact Us](#) | [Site Map](#) | [Privacy Policy](#) | [Bookmark This Site](#) | [Home](#)

Copyright © 2003 - PennWell Corporation. All rights reserved.